

FIG. 1

Redistribution Layer Shielding of a Circuit Element

Ligang Zhang

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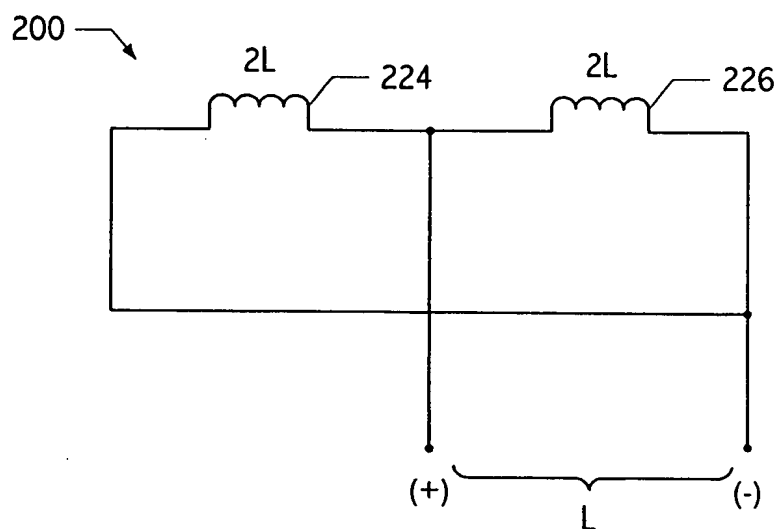


FIG. 2A

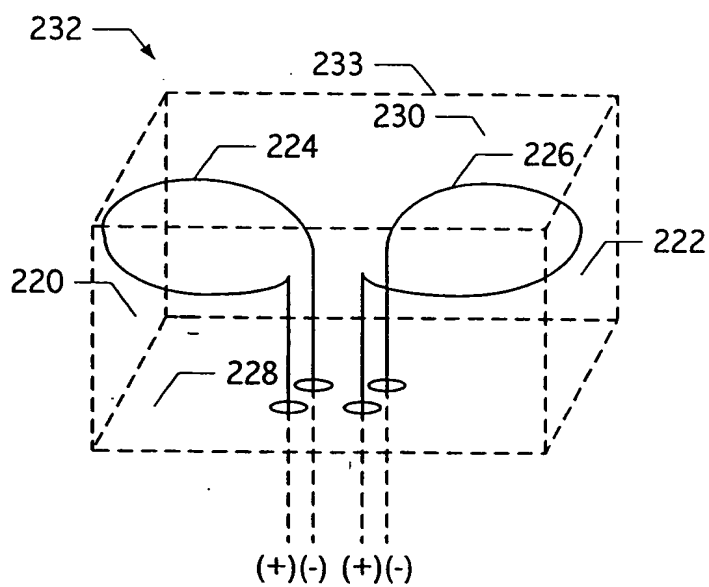


FIG. 2B

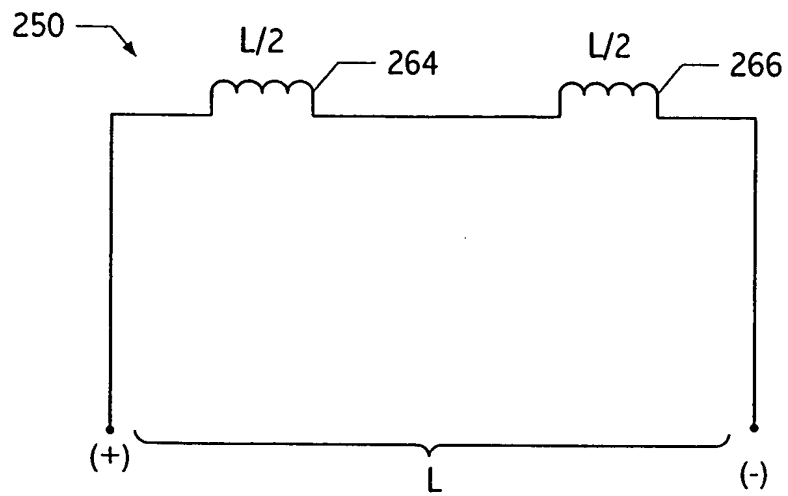


FIG. 2C

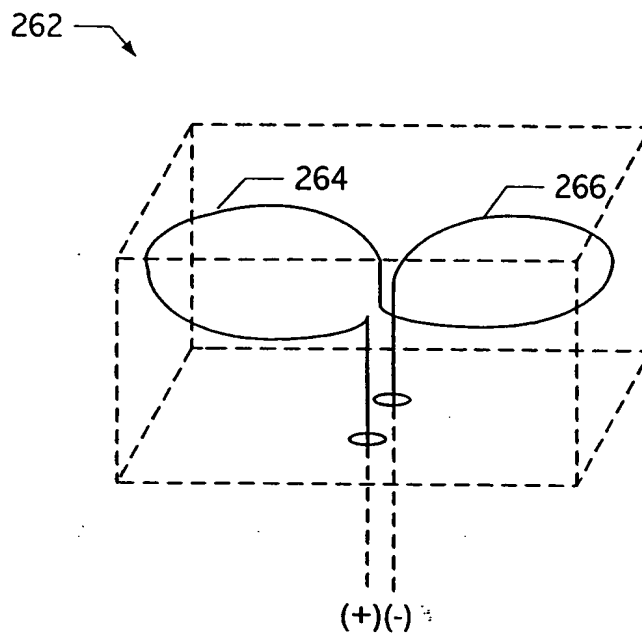


FIG. 2D

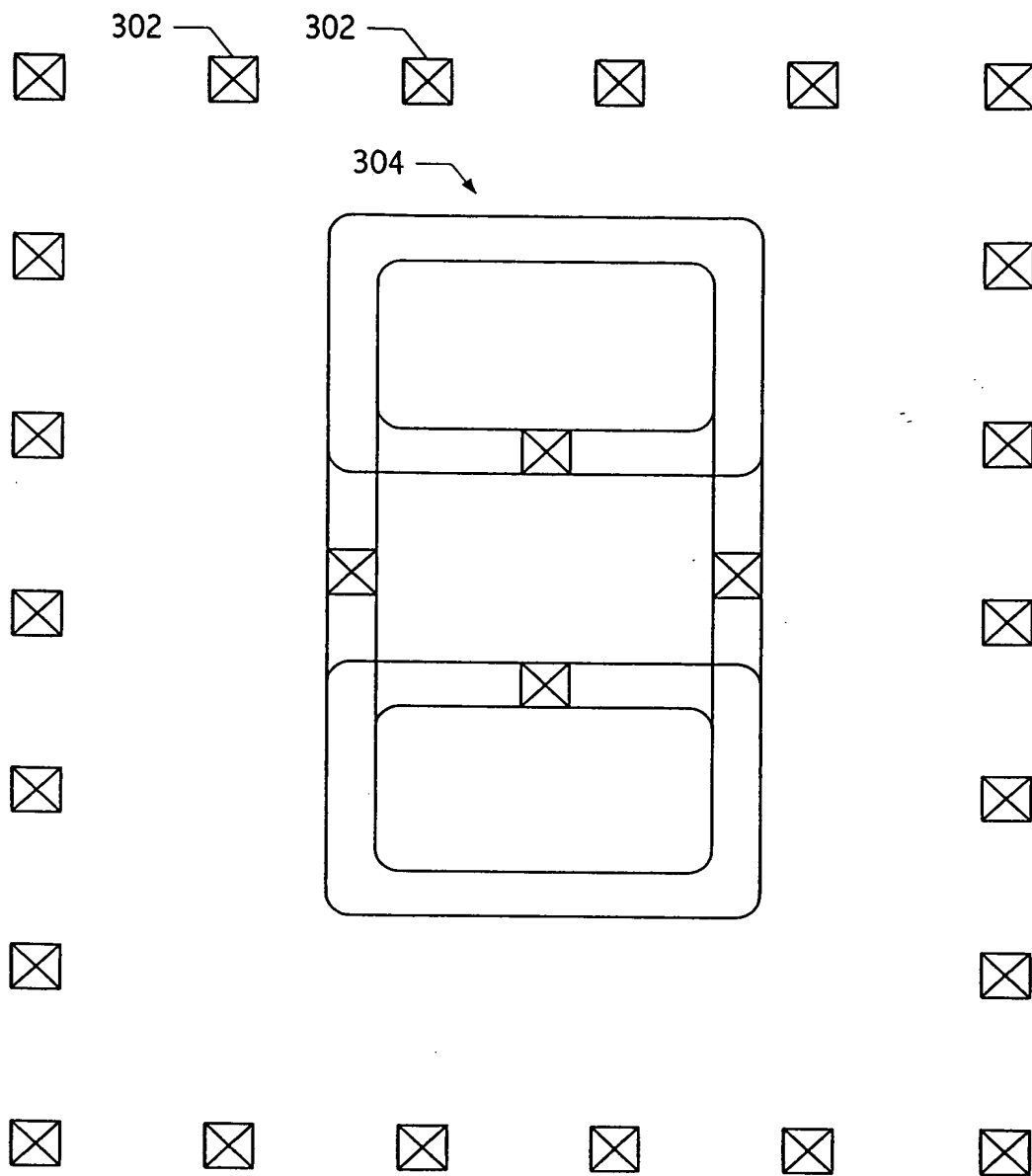


FIG. 3

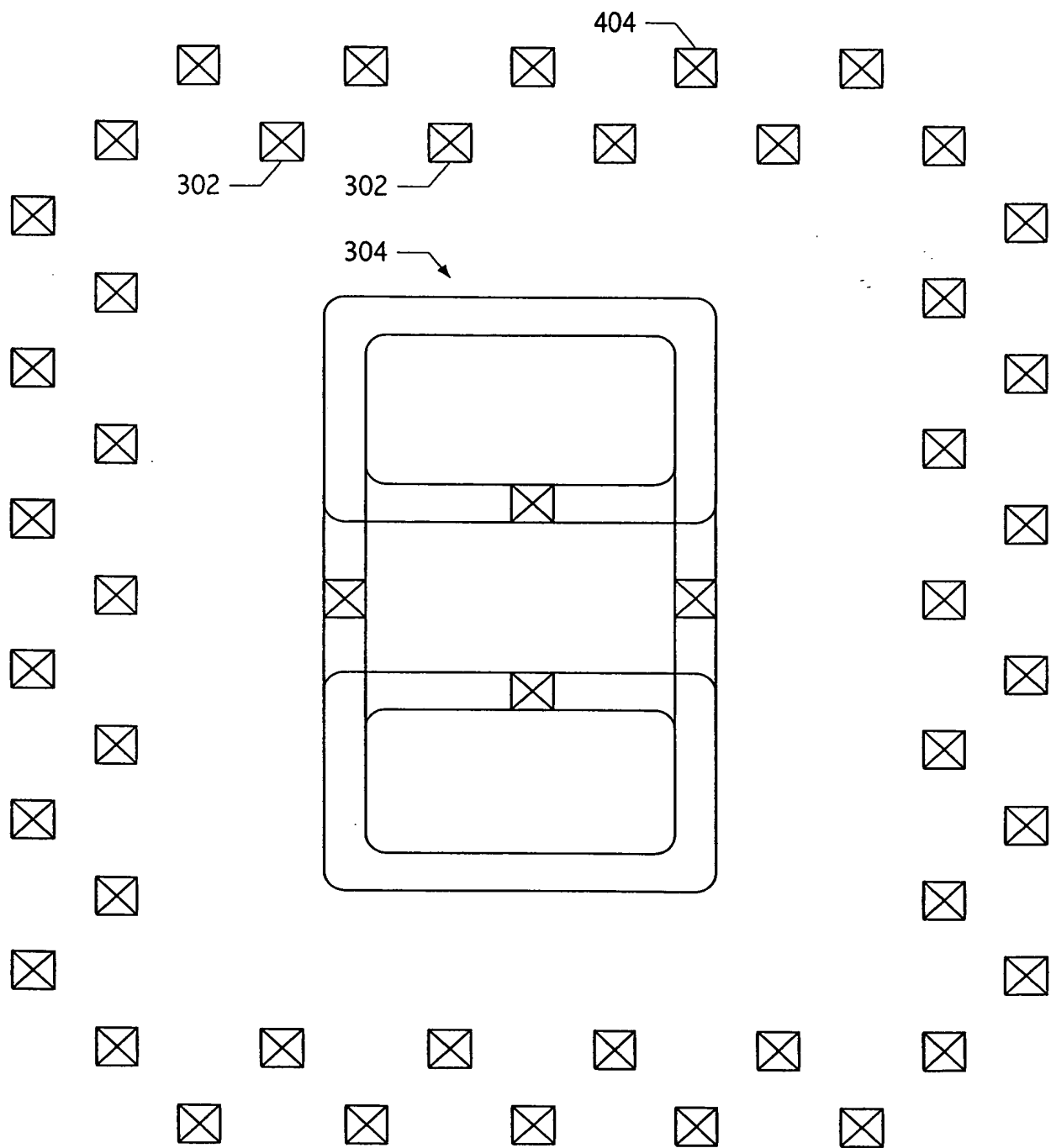


FIG. 4A

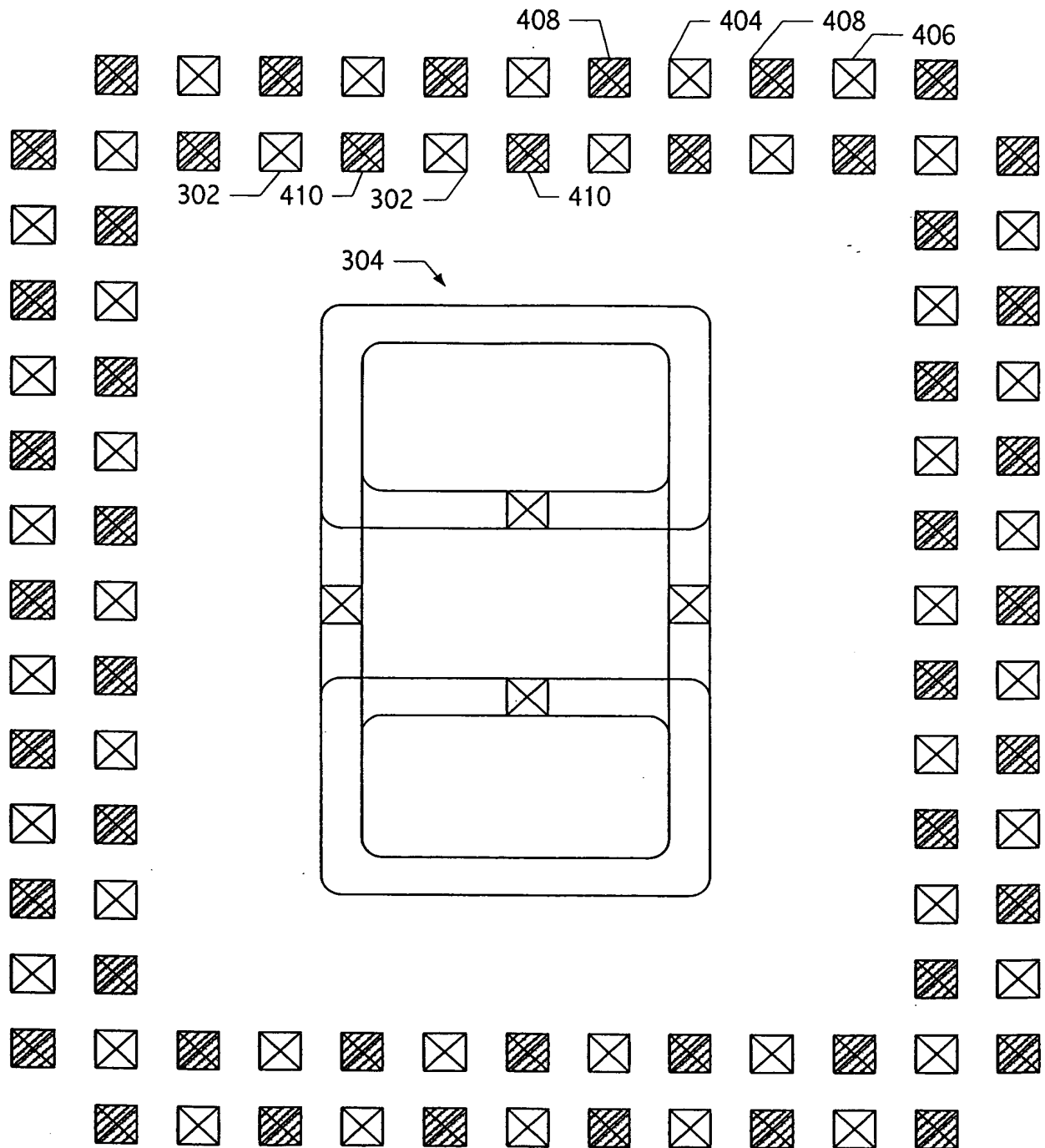


FIG. 4B

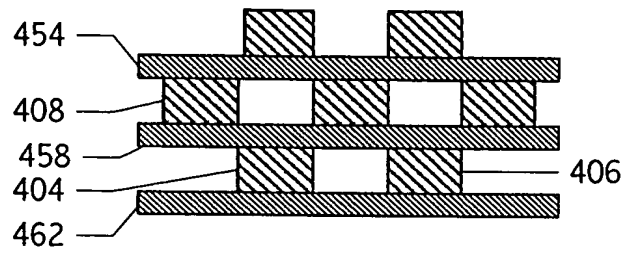


FIG. 4C

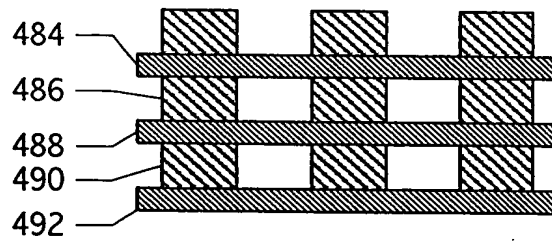


FIG. 4D

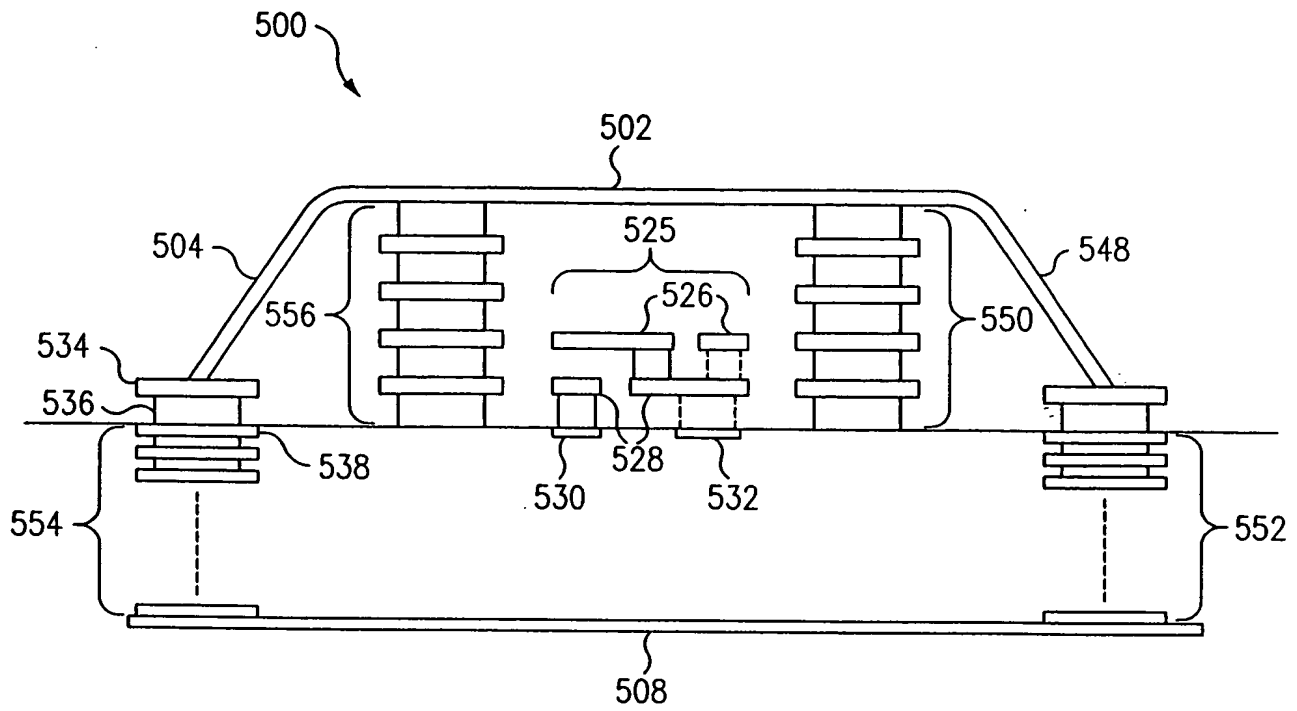


FIG. 5A

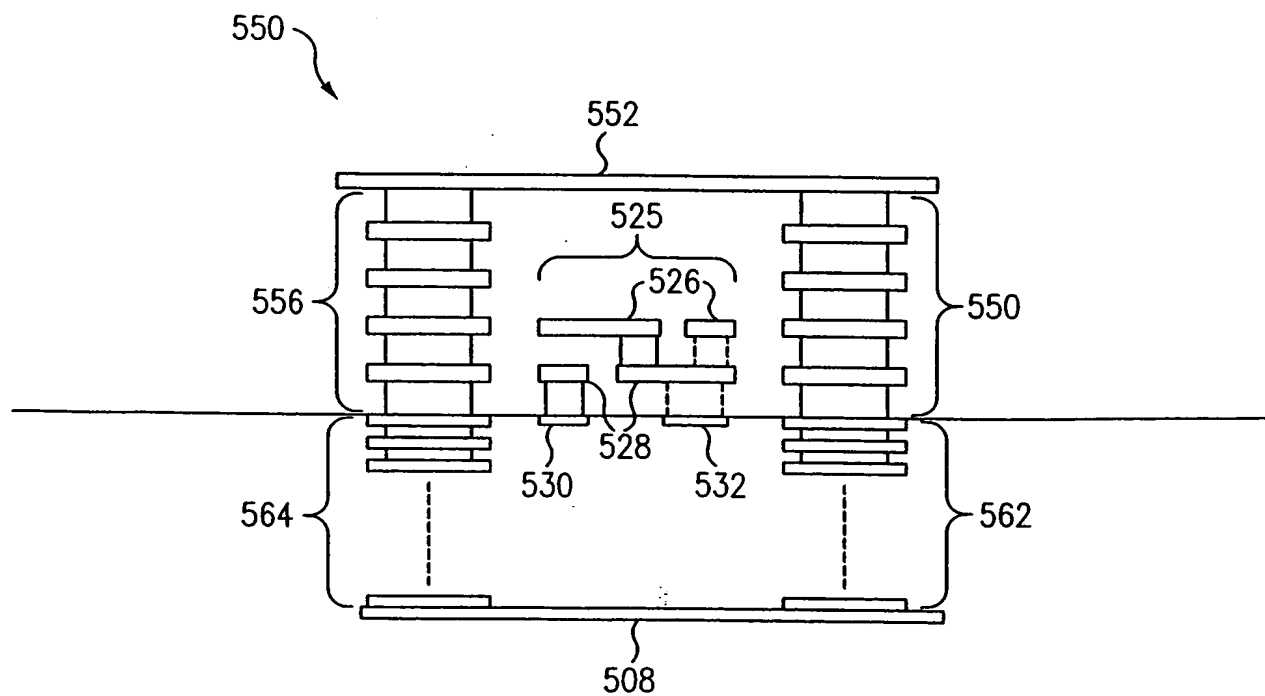


FIG. 5B

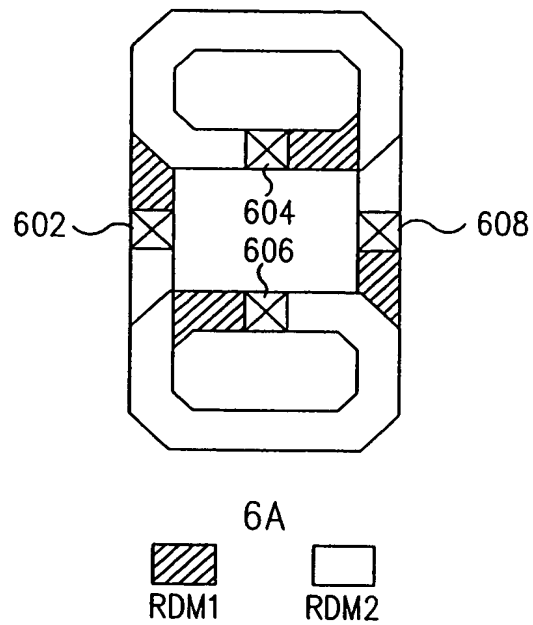


FIG. 6A

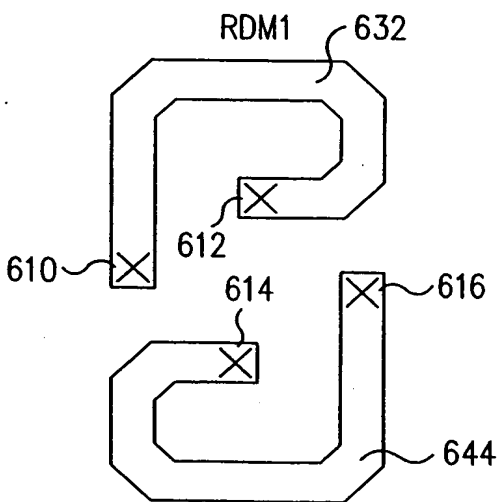


FIG. 6B

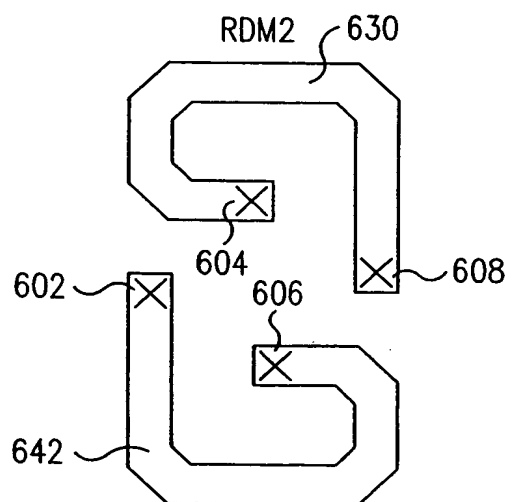


FIG. 6C

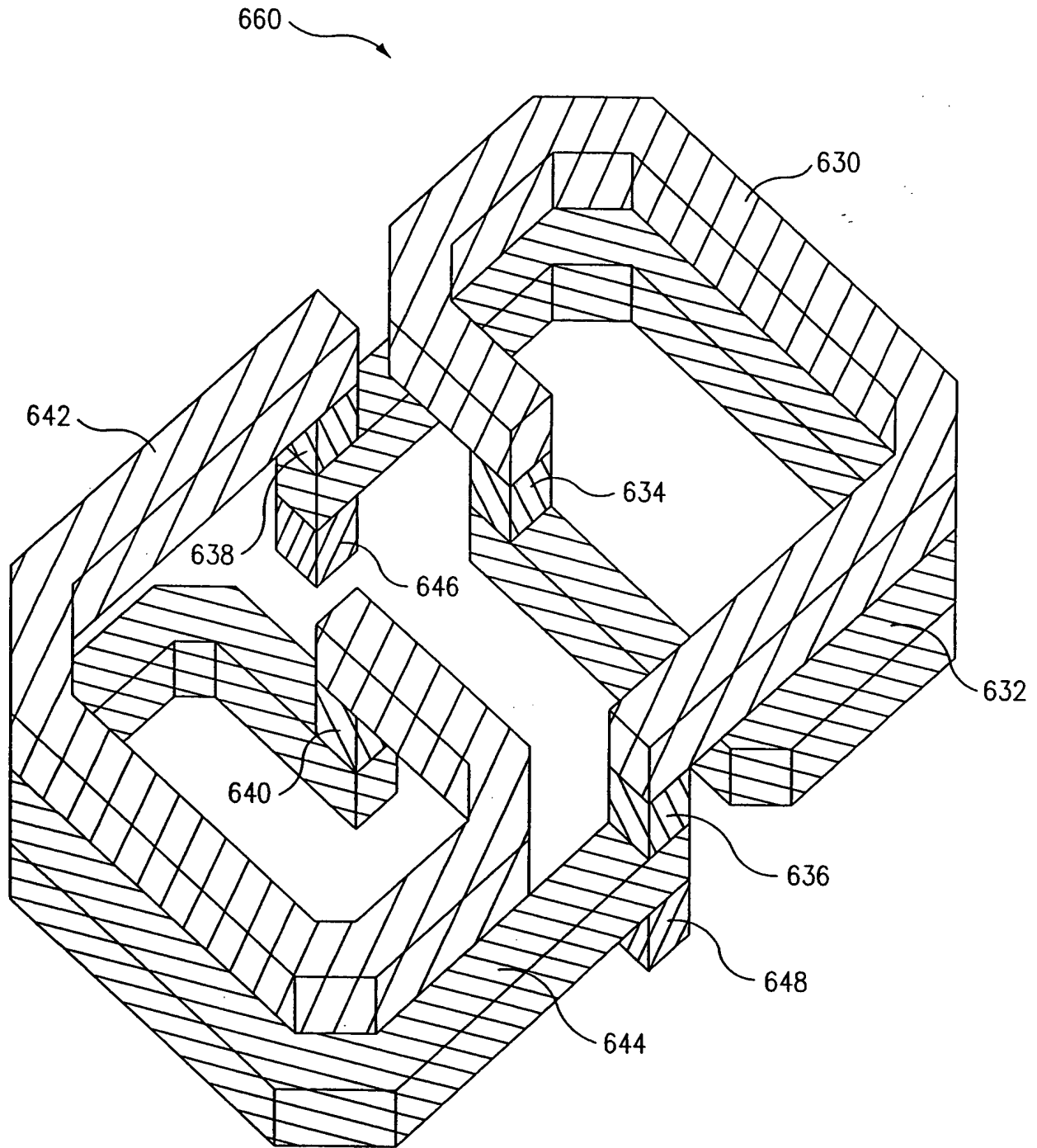


FIG. 6D

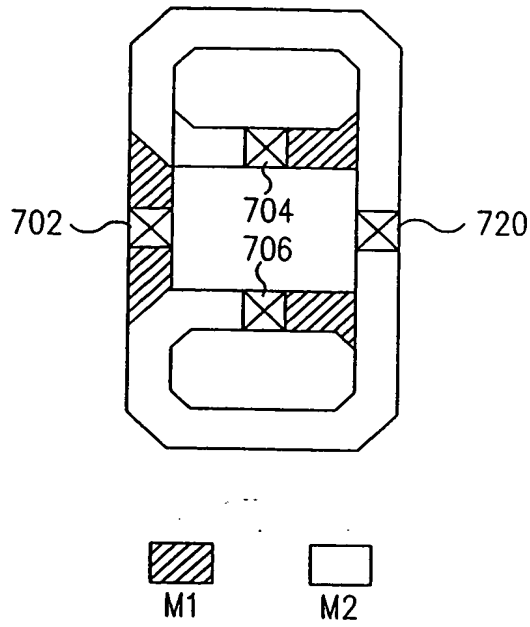


FIG. 7A

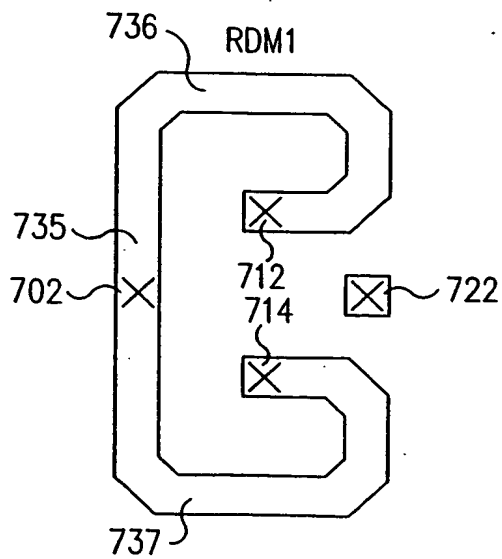


FIG. 7B

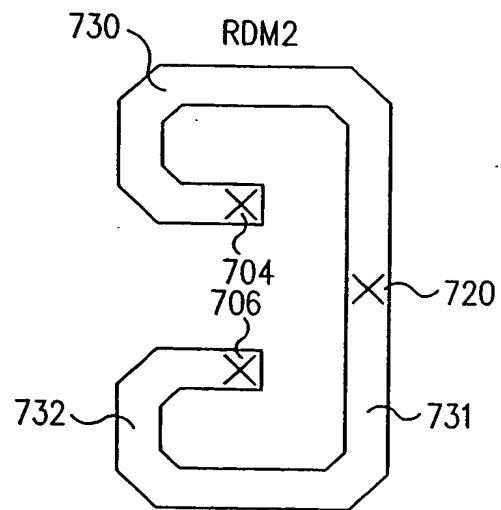


FIG. 7C

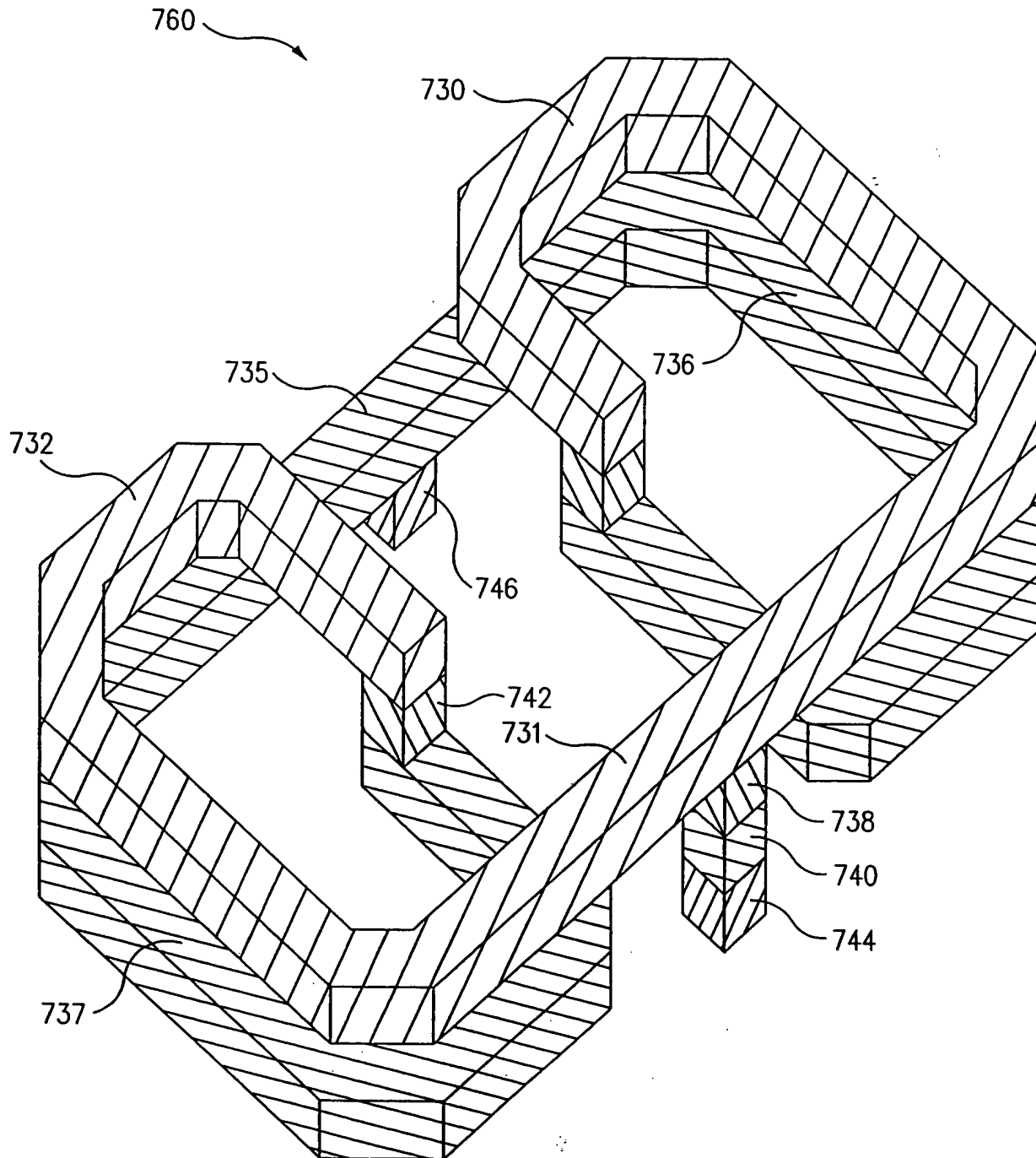


FIG. 7D

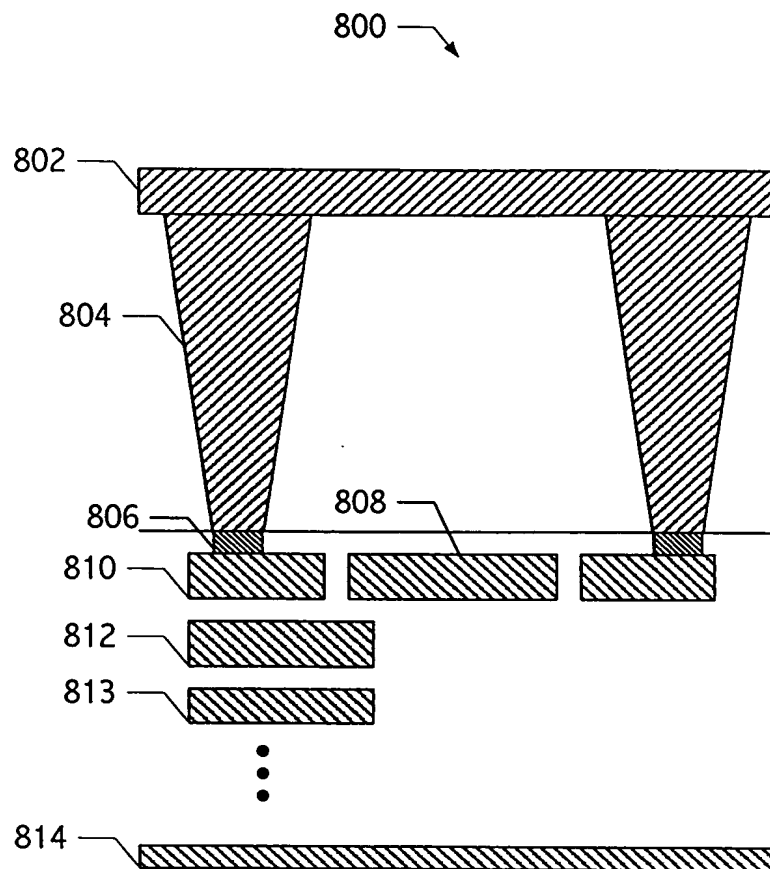


FIG. 8

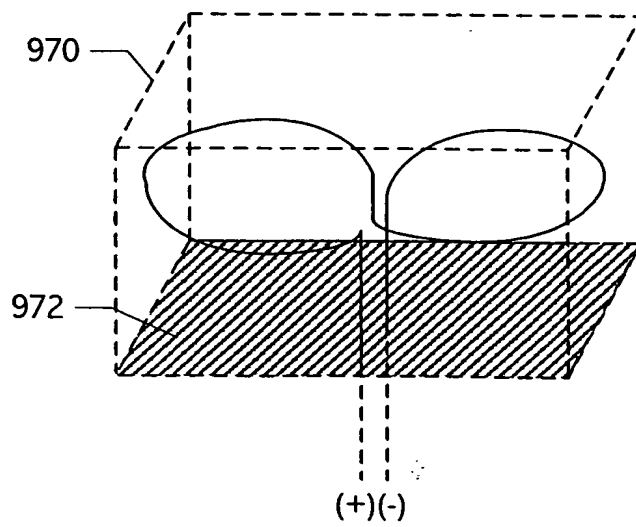


FIG. 9D

900

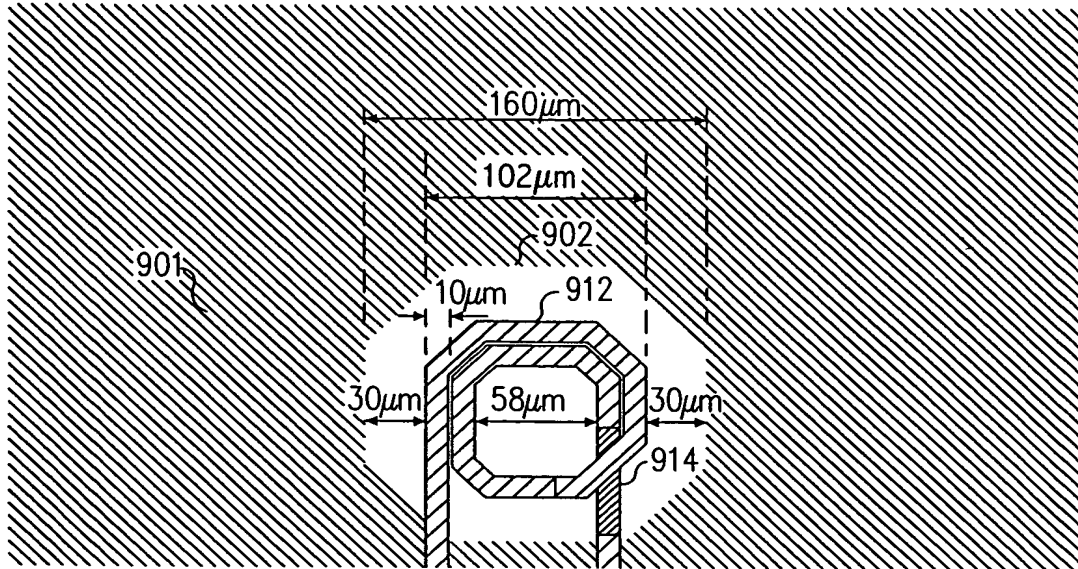


FIG. 9A

900

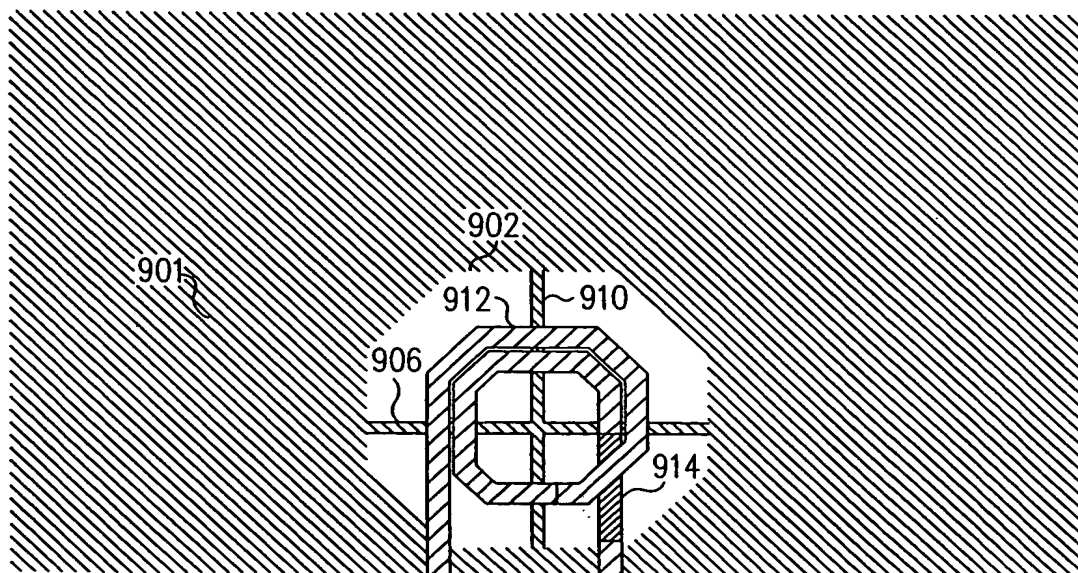


FIG. 9B

900

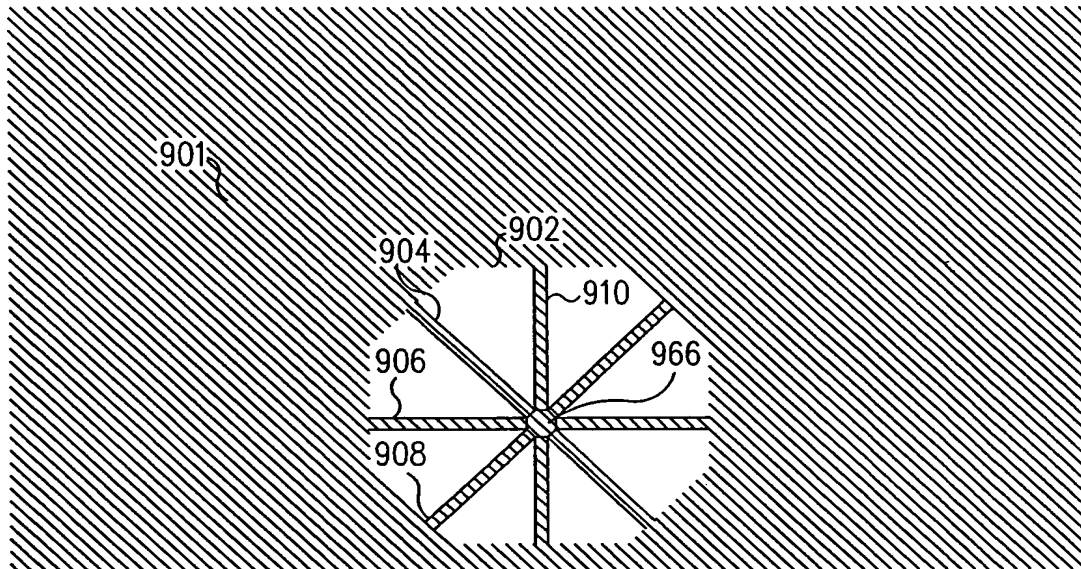


FIG. 9C

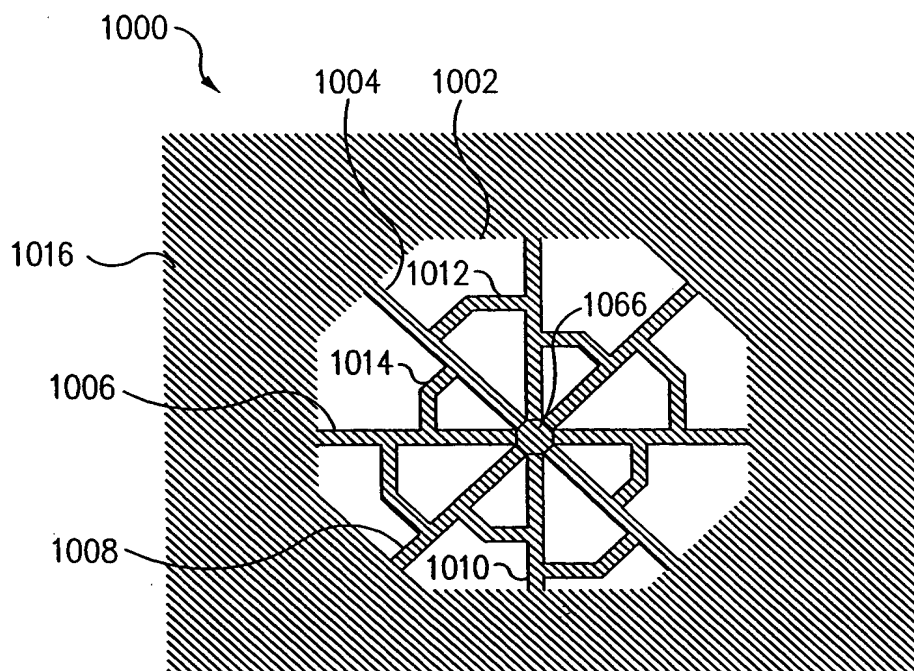


FIG. 10

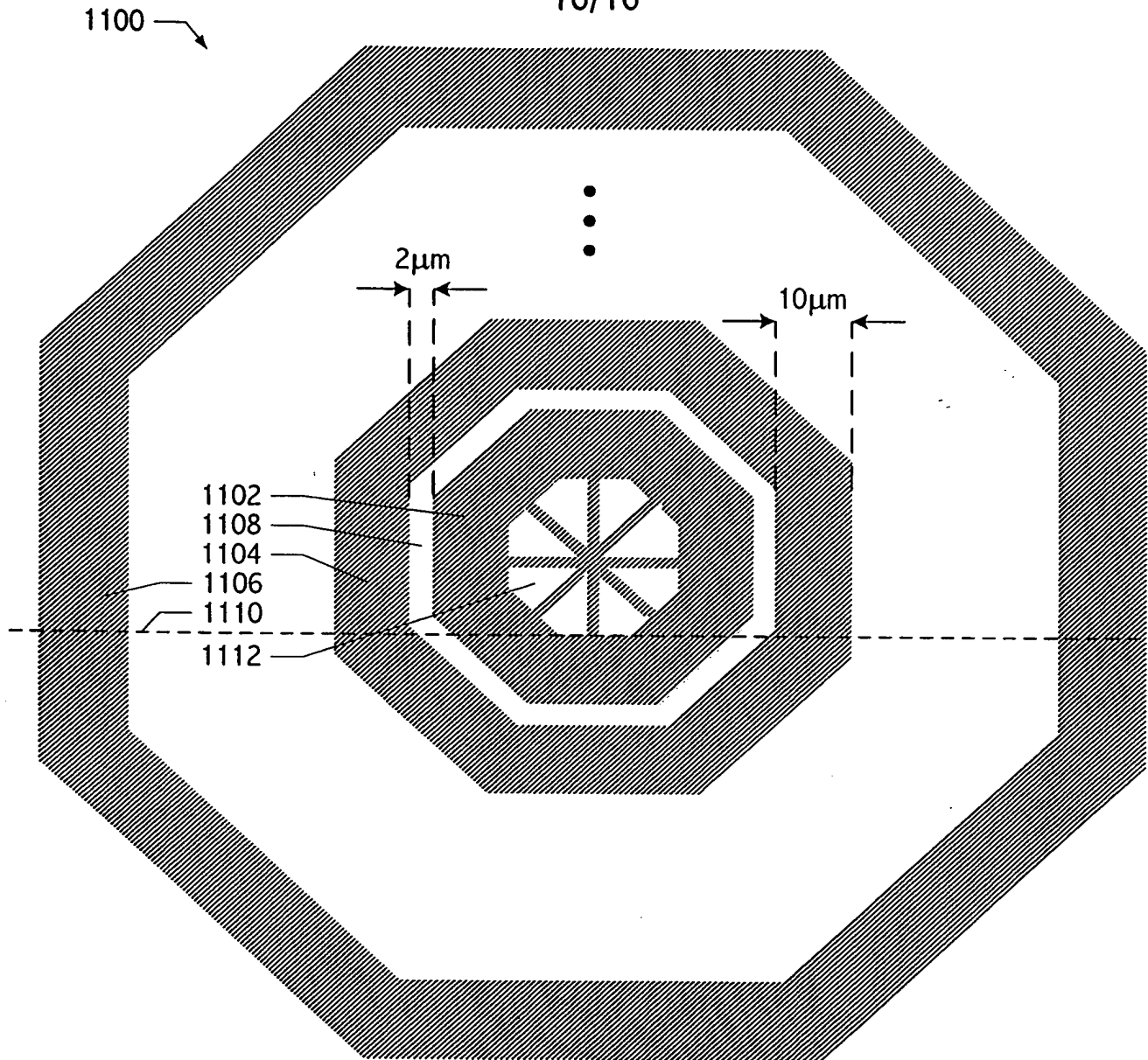


FIG. 11A

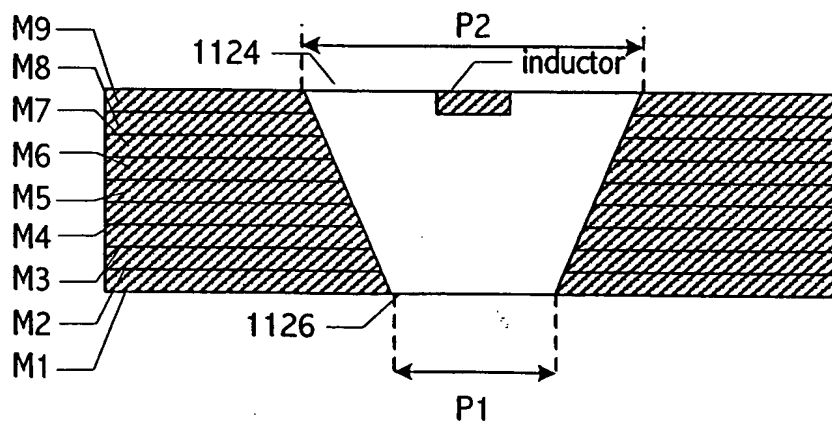


FIG. 11B